



ON Semiconductor®

# FMBM5551 NPN General-Purpose Amplifier

## Features

- This device has matched dies
- Sourced from process 16
- See MMBT5551 for characteristics

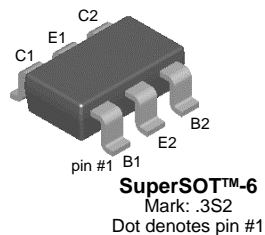


Figure 1. Device Package

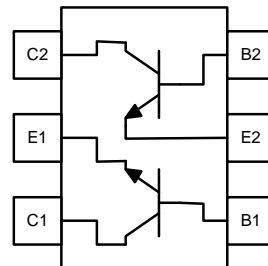


Figure 2. Internal Connection

## Ordering Information

Part Number	Top Mark	Package	Packing Method
FMBM5551	3S2	SSOT 6L	Tape and Reel

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
$V_{CEO}$	Collector-Emitter Voltage	160	V
$V_{CBO}$	Collector-Base Voltage	180	V
$V_{EBO}$	Emitter-Base Voltage	6	V
$I_C$	Collector Current (DC)	600	mA
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics<sup>(1), (2)</sup>

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	0.7	W
	Derate Above $25^\circ\text{C}$	5.6	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	180	$^\circ\text{C}/\text{W}$

**Notes:**

- $P_D$  total, for both transistors. For each transistor,  $P_D = 350$  mW.
- PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

### Electrical Characteristics

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
$BV_{CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 1$ mA, $I_B = 0$	160		V
$BV_{CBO}$	Collector-Base Breakdown Voltage	$I_C = 100$ $\mu\text{A}$ , $I_E = 0$	180		V
$BV_{EBO}$	Emitter-Base Breakdown Voltage	$I_E = 10$ $\mu\text{A}$ , $I_C = 0$	6		V
$I_{CBO}$	Collector Cut-Off Current	$V_{CB} = 120$ V, $I_E = 0$		50	nA
		$V_{CB} = 120$ V, $I_E = 0$ , $T_A = 100^\circ\text{C}$		50	$\mu\text{A}$
$I_{EBO}$	Emitter Cut-Off Current	$V_{EB} = 4$ V, $I_C = 0$		50	nA
$h_{FE1}$	DC Current Gain	$V_{CE} = 5$ V, $I_C = 1$ mA	80		
DIVID1	Variation Ratio of $h_{FE1}$ Between Die 1 and Die 2	$h_{FE1}(\text{Die1}) / h_{FE1}(\text{Die2})$	0.9	1.1	
$h_{FE2}$	DC Current Gain	$V_{CE} = 5$ V, $I_C = 10$ mA	80	250	
DIVID2	Variation Ratio of $h_{FE2}$ Between Die 1 and Die 2	$h_{FE2}(\text{Die1}) / h_{FE2}(\text{Die2})$	0.95	1.05	
$h_{FE3}$	DC Current Gain	$V_{CE} = 5$ V, $I_C = 50$ mA	30		
DIVID3	Variation Ratio of $h_{FE3}$ Between Die 1 and Die 2	$h_{FE3}(\text{Die1}) / h_{FE3}(\text{Die2})$	0.9	1.1	
$V_{CE}(\text{sat})$	Collector-Emitter Saturation Voltage	$I_C = 10$ mA, $I_B = 1$ mA		0.15	V
		$I_C = 50$ mA, $I_B = 5$ mA		0.20	
$V_{BE}(\text{sat})$	Base-Emitter Saturation Voltage	$I_C = 10$ mA, $I_B = 1$ mA		1	V
		$I_C = 50$ mA, $I_B = 5$ mA		1	
$V_{BE}(\text{on})$	Base-Emitter On Voltage	$V_{CE} = 5$ V, $I_C = 10$ mA		1	V
DEL	Difference of $V_{BE}(\text{on})$ Between Die1 and Die 2	$V_{BE}(\text{on})(\text{Die1}) - V_{BE}(\text{on})(\text{Die2})$	-8	8	mV
$C_{ob}$	Output Capacitance	$V_{CB} = 10$ V, $I_E = 0$ , $f = 1$ MHz		6	pF
$C_{ib}$	Input Capacitance	$V_{EB} = 0.5$ V, $I_C = 0$ , $f = 1$ MHz		20	pF
$f_T$	Current Gain Bandwidth Product	$V_{CE} = 10$ V, $I_C = 10$ mA, $f = 100$ MHz	100	300	MHz
NF	Noise Figure	$V_{CE} = 5$ V, $I_C = 200$ $\mu\text{A}$ , $f = 1$ MHz, $R_S = 20$ k $\Omega$ , $B = 200$ Hz		8	dB
$h_{fe}$	Small Signal Current Gain	$V_{CE} = 10$ V, $I_C = 1.0$ mA, $f = 10$ kHz	50	250	

## Typical Performance Characteristics

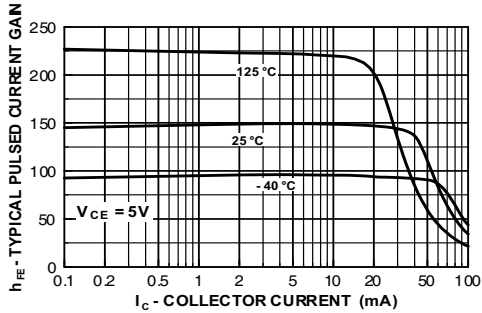


Figure 3. Typical Pulsed Current Gain vs. Collector Current

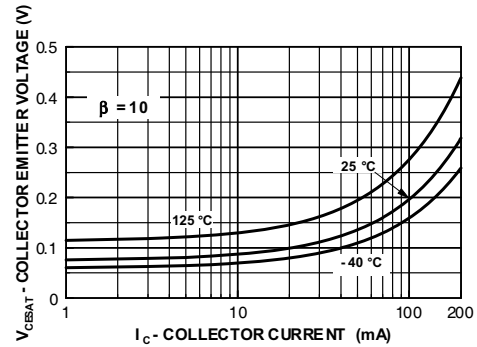


Figure 4. Collector-Emitter Saturation Voltage vs. Collector Current

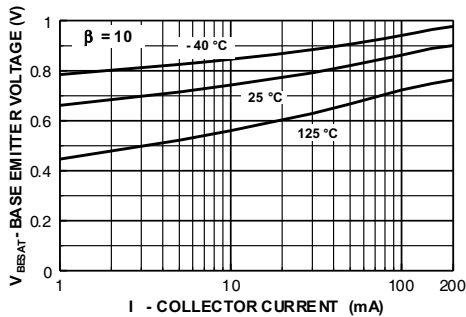


Figure 5. Base-Emitter Saturation Voltage vs. Collector Current

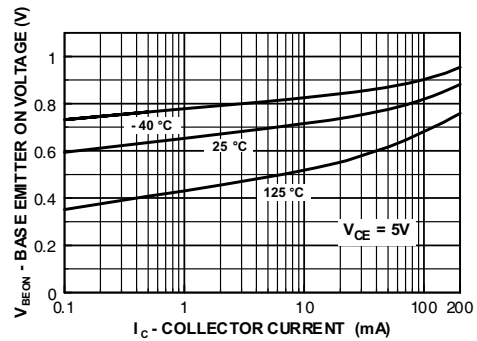


Figure 6. Base-Emitter On Voltage vs. Collector Current

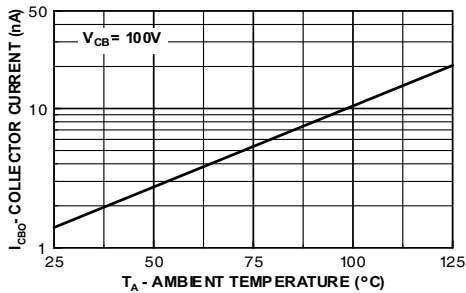


Figure 7. Collector Cut-Off Current vs. Ambient Temperature

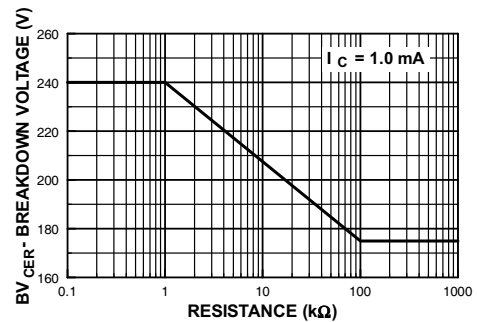
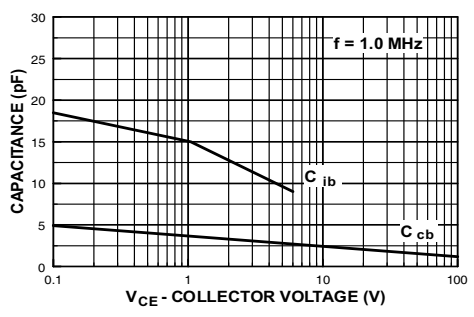
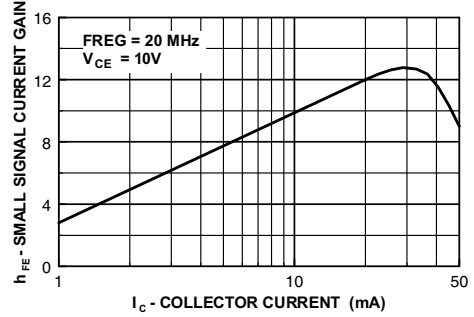


Figure 8. Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base

**Typical Performance Characteristics** (Continued)

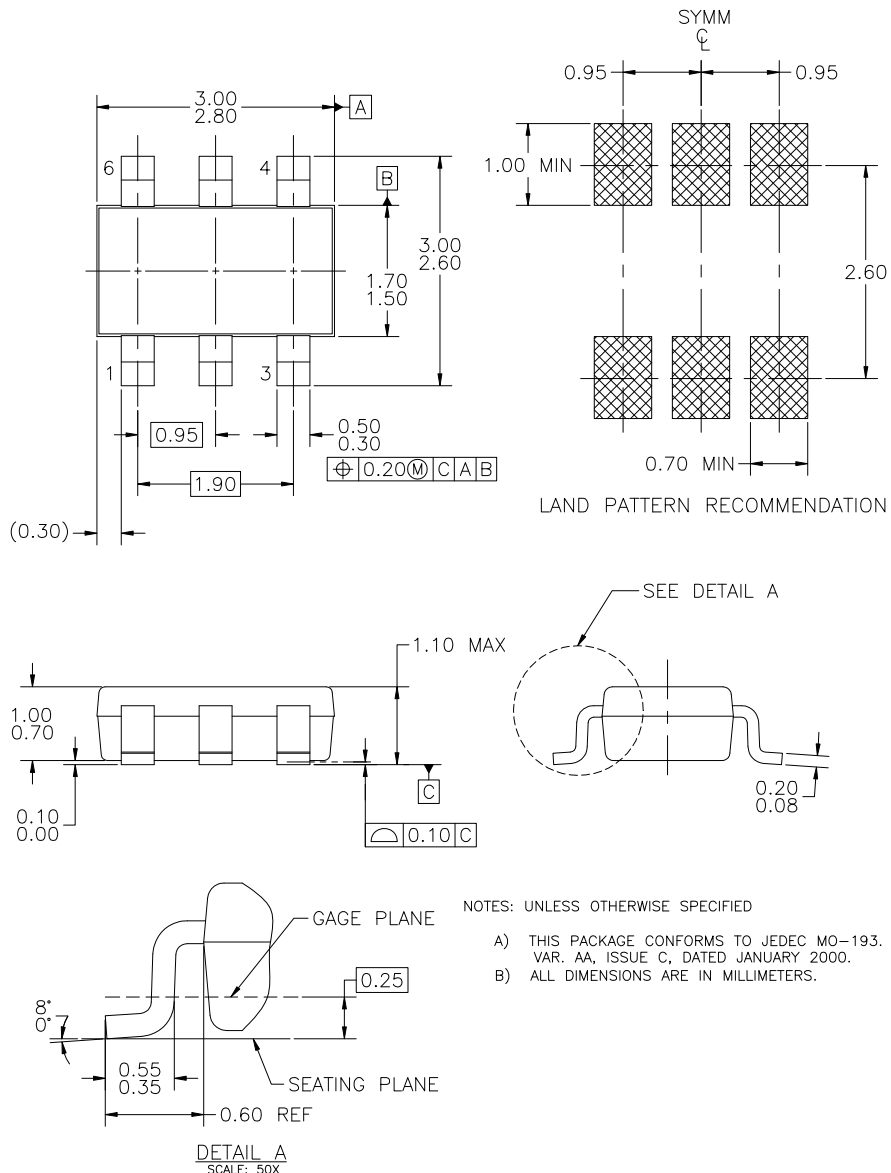


**Figure 9. Input and Output Capacitance vs. Reverse Voltage**



**Figure 10. Small Signal Current Gain vs. Collector Current**

**Physical Dimensions**



**Figure 11. 6-LEAD, SUPERSOT6, JEDEC MO-193, 1.6 MM WIDE**

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative